



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(ON) Max	I _D T _A = +25°C
-20V	0.75Ω @ V _{GS} = -4.5V	-0.99A
	1.05Ω @ V _{GS} = -2.5V	-0.83A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Load Switch

X1-DFN1006-3





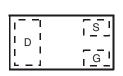
Bottom View

Features and Benefits

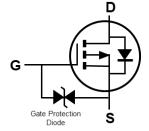
- 0.6mm² Footprint—Thirteen Times Smaller than SOT23
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: X1-DFN1006-3
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)







Equivalent Circuit

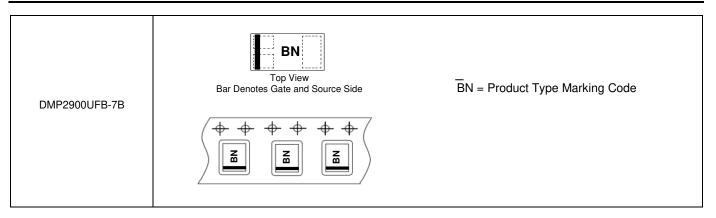
Ordering Information (Note 4)

Part Number	Dookogo	Packing		
Part Number	Package	Qty.	Carrier	
DMP2900UFB-7B	X1-DFN1006-3	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V_{GSS}	±6	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25°C T _A = +70°C	l In	-0.99 -0.79	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	-2.6	A		

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	0.55	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{OJA}	229	°C/W
Total Power Dissipation (Note 6)	PD	1.11	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	113	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

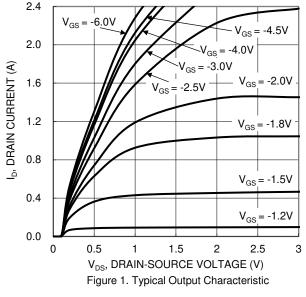
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

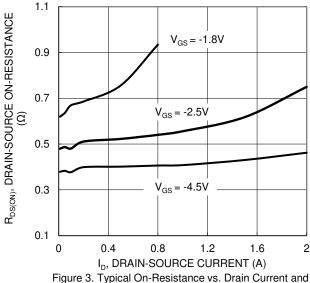
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C			_	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±2.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.5		-1.0	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
			0.4	0.75		$V_{GS} = -4.5V$, $I_{D} = -430mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	0.5	1.05	Ω	$V_{GS} = -2.5V$, $I_D = -300mA$	
		_	0.67	1.5		V _{GS} = -1.8V, I _D = -150mA	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -150mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		49	_	рF	101/11/101/	
Output Capacitance	Coss		12	_	рF	$V_{DS} = -16V, V_{GS} = 0V,$	
Reverse Transfer Capacitance	Crss	_	3.4	_	рF	f = 1.0MHz	
Total Gate Charge	Qg	_	0.7	_	nC	V 45V V 10V	
Gate-Source Charge	Q _{gs}	_	0.1	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge	Qgd	_	0.1	_	nC	I _D = -250mA	
Turn-On Delay Time	t _{D(ON)}	_	16	_	ns	401/1/ 451/	
Turn-On Rise Time	tR	_	15	_	ns	V _{DS} = -10V, V _{GS} = -4.5V,	
Turn-Off Delay Time	tD(OFF)	_	213	_	ns	$R_g = 10\Omega$, $R_L = 47\Omega$	
Turn-Off Fall Time		_	89	_	ns	I _D = -200mA	

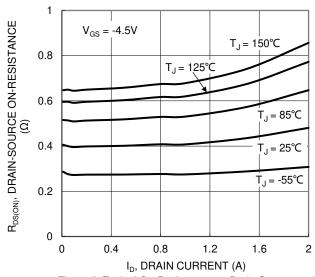
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm \times 25mm square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.



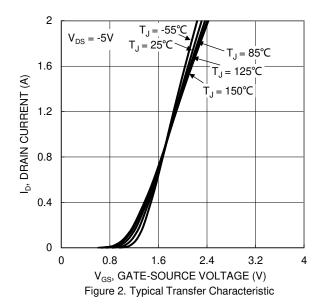


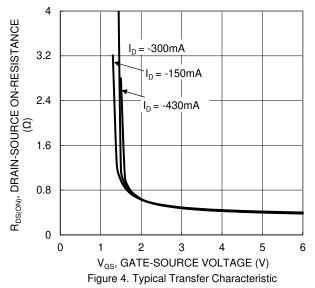




Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





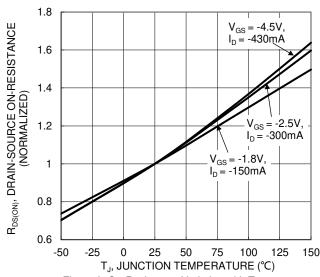
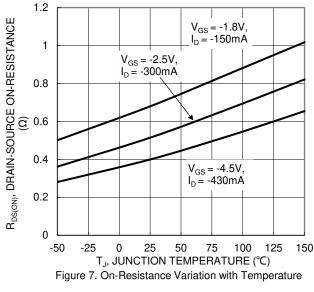


Figure 6. On-Resistance Variation with Temperature





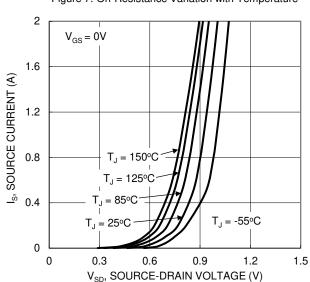
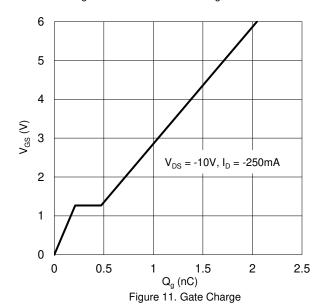


Figure 9. Diode Forward Voltage vs. Current



2 $V_{\text{GS(TH)}}$, GATE THRESHOLD VOLTAGE (V) 1.6 1.2 $I_D = -1 \text{mA}$ 8.0 $I_{D} = -250 \mu A$ 0.4 0 -50 100 125 150 25 50 75 T_J, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature

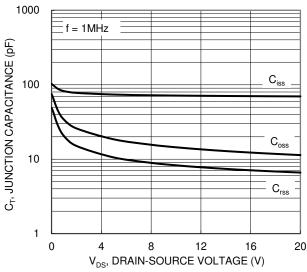
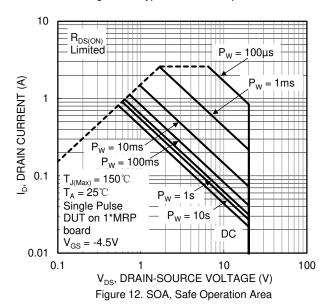


Figure 10. Typical Junction Capacitance





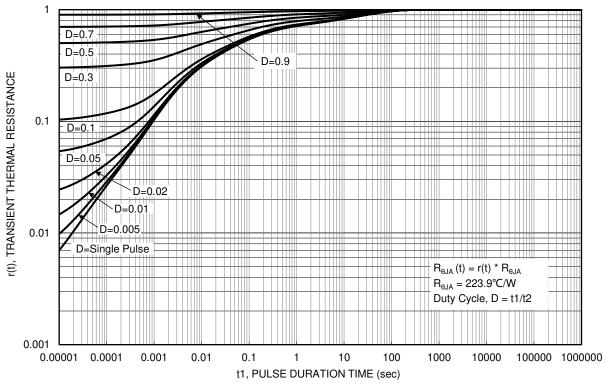


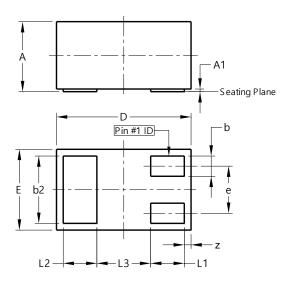
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3

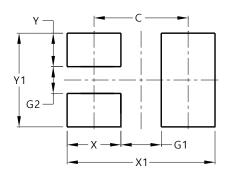


X1-DFN1006-3					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A 1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3	-	-	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3



Dimensions	Value (in mm)		
С	0.70		
G1	0.30		
G2	0.20		
Х	0.40		
X1	1.10		
Υ	0.25		
Y1	0.70		



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